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101541762 PATENTS, TRADEMARKS, COPYRIGHTS UNFAIR COMPETITION LAW AND RELATED LITIGATION

11-20-00

12-06-2000

PAUL L. BROWN JAMES J. HILL HARRY M. LEVY ROBERT R. CALIRI THOMAS E. HILL JONATHAN J. KRIT

November 16, 2000

Assistant Commissioner for Patents Box Assignments Washington, D.C. 20231

Re:

ANL-IN-00-042

Case 200

Serial No, 09/621,272 Filed: July 20, 2000

Argonne National Laboratory The University of Chicago

Inventors: U. Balachandran and Michael P. Chudzik

For: METHOD FOR PREPARING HIGH TEMPERATURE SUPERCONDUCTOR

Sir:

Please record the attached original document or copy thereof.

1. Name of conveying party(ies):

Uthamalingam Balachandran and Michael P. Chudzik

2. Name and address of receiving party(ies):

> The University of Chicago 5801 South Ellis Street Chicago, Illinois 60637

3. Nature of Conveyance:

> Patent Assignment dated August 16, 2000 and August 8, 2000, respectively.

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PATENT REEL: 011301 FRAME: 0844

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Assistant Commissioner for Patents Page -2-November 16, 2000

- 4. The enclosed Assignment is filed in connection with application Serial No. 09/621,272 filed July 20, 2000.
- 5. Name and address of party to whom correspondence concerning document should be mailed:

Harry M. Levy, Esq. Emrich & Dithmar Suite 3000, 300 South Wacker Drive Chicago, Illinois 60606

- 6. Total number of applications involved: 1.
- 7. Total fee enclosed (37 CFR 3.41): \$40.00
- 8. Please charge any additional fees or credit any overpayment to Deposit Account No. 05-1060. A duplicate copy of this letter is enclosed.
- 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Total Number of Pages Including Cover Sheet: 4

PATENT REEL: 011301 FRAME: 0845

ASSIGNMENT

I, Michael P. Chudzik of Beacon, New York, for good and valuable considerations to me in hand paid, the receipt and sufficiency whereof is hereby acknowledged, have sold, assigned, conveyed and set over, and do hereby sell, assign, convey and set over unto THE UNIVERSITY OF CHICAGO, an Illinois corporation, organized under the laws of the State of Illinois, having a place of business at 5801 South Ellis Avenue, Chicago, Illinois 60637, its successors and assigns, the entire right, title and interest in and to all subject matter invented or designed by me and disclosed in the patent application for the METHOD FOR PREPARING HIGH TEMPERATURE SUPERCONDUCTOR, ANL Case No. ANL-IN-00-042, filed in the U.S. Patent and Trademark Office on July 20, 2000, and any divisions and continuations thereof and in and to all Letters Patent of the United States, including any reissues and extensions thereof that may be obtained therefor, and the right, where such right can be legally exercised, in its own name to apply for and obtain Letters Patent, Inventor's Certificates, Utility Models and Designs. in countries foreign to the United States, including the full right to claim for any such application the benefits of the International Convention as fully and entirely as I could have done if the application had been in my name, and the entire interest in any Letters Patent, Inventor's Certificate, Utility Model or Design which may be granted on any such application in such foreign country; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue Letters Patent, Inventors Certificates, Utility Models or Designs, on applications as aforesaid, to issue any and all Letters Patent, Inventor's Certificates. Utility Models and Designs that may be granted for said invention to said UNIVERSITY OF CHICAGO, its successors and assigns.

And for the above-named considerations, I hereby agree that I will without additional compensation but without cost to myself, promptly communicate to said UNIVERSITY OF CHICAGO, its successors and assigns, any facts known to me respecting said invention whenever requested, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications for Letters Patent, Inventor's Certificates, Utility Models and Designs and assignments thereof, make all rightful oaths and generally do everything possible to aid said assignee, its successors and assigns, as and when requested by them, in obtaining and enforcing proper Letters Patents, Inventor's Certificate, Utility Model and Design protection for said invention or inventions and improvements, in the United States and in all other countries.

Michael P. Chudzik

daves, Onderic

Date /

Witness

Date

PATENT REEL: 011301 FRAME: 0846

ASSIGNMENT

I, Uthamalingam Balachandran of Hinsdale, in the State of Illinois, for good and valuable considerations to me in hand paid, the receipt and sufficiency whereof is hereby acknowledged, have sold, assigned, conveyed and set over, and do hereby sell, assign, convey and set over unto THE UNIVERSITY OF CHICAGO, an Illinois corporation, organized under the laws of the State of Illinois, having a place of business at 5801 South Ellis Avenue, Chicago, Illinois 60637, its successors and assigns, the entire right, title and interest in and to all subject matter invented or designed by me and disclosed in the patent application for the METHOD FOR PREPARING HIGH TEMPERATURE SUPERCONDUCTOR, filed in the U.S. Patent and Trademark Office on July 20, 2000, and in and any divisions and continuations thereof and in and to all Letters Patent of the United States, including any reissues and extensions thereof that may be obtained therefor, and the right, where such right can be legally exercised, in its own name to apply for and obtain Letters Patent, Inventor's Certificates, Utility Models and Designs, in countries foreign to the United States, including the full right to claim for any such application the benefits of the International Convention as fully and entirely as I could have done if the application had been in my name, and the entire interest in any Letters Patent, Inventor's Certificate, Utility Model or Design which may be granted on any such application in such foreign country; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue Letters Patent, Inventors Certificates, Utility Models or Designs, on applications as aforesaid, to issue any and all Letters Patent, Inventor's Certificates, Utility Models and Designs that may be granted for said invention to said UNIVERSITY OF CHICAGO, its successors and assigns.

And for the above-named considerations, I hereby agree that I will without additional compensation but without cost to myself, promptly communicate to said UNIVERSITY OF CHICAGO, its successors and assigns, any facts known to us respecting said invention whenever requested, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications for Letters Patent, Inventor's Certificates, Utility Models and Designs and assignments thereof, make all rightful oaths and generally do everything possible to aid said assignee, its successors and assigns, as and when requested by them, in obtaining and enforcing proper Letters Patents, Inventor's Certificate, Utility Model and Design protection for said invention or inventions and improvements, in the United States and in all other countries.

Dated: Ay 16, 2000 2 Milyon Barroon.

STATE OF ILLINOIS)

COUNTY OF DU PAGE) ss

On this day of d

WITNESS my hand and seal the day and year last above given.

RECORDED: 11/20/2000

" OFFICAL SEAL "
MIRIAM R. LEGAN
NOTARY PUBLIC, STATE OF ILLINOIS
MY COMMISSION EXP. 18/8/2003

PATENT

Murian & Ligar Notary Public

REEL: 011301 FRAME: 0847